# Wideband Distributed Amplifier 100 kHz - 50 GHz



MAAM-011238

Rev. V5

#### **Features**

- Gain: 14 dB @ 6 V, 30 GHz
  P1dB: 17 dBm @ 6 V, 30 GHz
- P3dB: 18.5 dBm @ 6 V, 30 GHz
- Integrated Power Detector
- · Gain control with only positive bias voltages
- 50  $\Omega$  Input and Output Match
- Bias Voltage: VDD = 4 6 V
- Bias Current: IDSQ = 125 150 mA
- 5 mm SMT Package
- RoHS\* Compliant

### **Applications**

• Instrumentation and Communication Systems

#### Description

MAAM-011238 is an easy-to-use, wideband amplifier that operates from 100 kHz to 50 GHz. The amplifier provides 14 dB gain, 5 dB noise figure and 18.5 dBm of P3dB output power @ 30 GHz. It is matched to 50  $\Omega$  with typical return loss of 12 dB. The amplifier requires only positive bias voltages and would typically be operated at 6 V and 135 mA.

MAAM-011238 is suitable for a wide range of applications in instrumentation and communication systems.

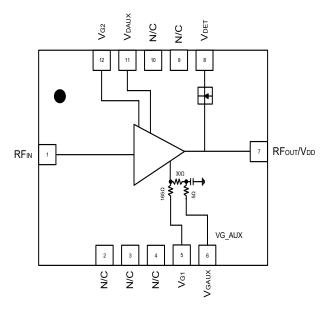
This part is also available as a bare die. Refer to datasheet MAAM-011238-DIE.

# Ordering Information<sup>1</sup>

Part Number	Package
MAAM-011238-TR0100	100 part reel
MAAM-011238-TR0500	500 part reel
MAAM-011238-SB1	Sample Board

1. Reference Application Note M513 for reel size information.

#### **Functional Schematic**



# Pad Configuration<sup>2,3</sup>

Pin #	Pin Name	Description
1	RFIN	RF Input / Gate Voltage
5	$V_{G1}$	Gate Voltage 1
6	$V_{GAUX}$	Auxiliary Gate Voltage
7	RFout/Vpd	RF Output / Drain Voltage
8	VDET	Detector Voltage
11	$V_{DAUX}$	Auxiliary Drain Voltage
12	$V_{G2}$	Gate Voltage 2
2, 3, 4, 9, 10	N/C	No Connection

- MACOM recommends connecting all no connection (N/C) pins to ground.
- The exposed pad centered on the package bottom must be connected to RF, DC and thermal ground.

<sup>\*</sup> Restrictions on Hazardous Substances, compliant to current RoHS EU directive.

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# Electrical Specifications<sup>4,5,6</sup>: $T_A = 25$ °C, $V_{DD} = 6$ V, $I_{DSQ} = 135$ mA, $Z_0 = 50$ $\Omega$

Parameter	Test Conditions	Units	Min.	Тур.	Max.
Gain	0.01 - 10 GHz 10 - 20 GHz 20 - 30 GHz 30 - 40 GHz 40 - 43.5 GHz 43.5 - 50 GHz	dB	13.0 12.5 11.0 11.0 10.0	16.0 15.0 14.0 13.0 12.5 12.5	_
Noise Figure	2 - 10 GHz 10 - 20 GHz 20 - 30 GHz 30 - 40 GHz 40 - 43.5 GHz 43.5 - 50 GHz	dB	_	5.0 4.0 5.0 7.0 6.5 9.0	_
Input Return Loss	0.01 - 20 GHz 20 - 30 GHz 30 - 40 GHz 40 - 43.5 GHz 43.5 - 50 GHz	dB	_	20.0 12.0 10.0 11.0 10.5	_
Output Return Loss	0.01 - 10 GHz 10 - 20 GHz 20 - 30 GHz 30 - 40 GHz 40 - 43.5 GHz 43.5 - 50 GHz	dB	_	19.5 20.0 13.0 9.5 10.0 11.0	_
P <sub>OUT</sub> @ P <sub>IN</sub> = 11 dBm	0.1 - 10 GHz 10 - 20 GHz 20 - 30 GHz 30 - 40 GHz 40 - 43.5 GHz 43.5 - 50 GHz	dBm	20.0 19.5 18.0 17.0 17.0	21.5 21.0 19.5 19.0 18.7 18.3	_
P1dB	0.1 - 20 GHz 20 - 30 GHz 30 - 40 GHz 40 - 43.5 GHz 43.5 - 50 GHz	dBm	_	18.0 17.0 16.0 15.5 15.0	_
P3dB	0.1 - 10 GHz 10 - 20 GHz 20 - 30 GHz 30 - 40 GHz 40 - 50 GHz	dBm	_	20.5 20.0 18.5 18.0 17.0	_
Output IP3	0.01 - 10 GHz 10 - 20 GHz 20 - 30 GHz 30 - 40 GHz 40 - 43.5 GHz 43.5 - 50 GHz	dBm	_	28.0 29.0 27.0 25.0 24.0 20.5	_
Drain Current	Quiescent bias	mA	_	135	_

<sup>4.</sup> Set IDSQ according to bias procedures in page 3.

<sup>5.</sup> Graphs in datasheet use test conditions shown unless otherwise stated.

<sup>6.</sup> All data measured with package assembled as per the Assembly Guideline.



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#### **Operating Conditions**

One of the recommended biasing conditions is  $V_{DD}$  = 6 V,  $I_{DSQ}$  = 135 mA. (controlled with  $V_{G1}$ ).  $I_{DSQ}$  is set by adjusting  $V_{G1}$  after correctly setting  $V_{DD}$ . (Refer to turn on sequence.)

Device biasing is achieved with the use of an external DC block on the input and a bias tee. The required  $V_{DD}$  is applied at RFout/VDD through the bias tee and  $V_{G1}$  is set to provide the required current bias ( $I_{DSQ}$ ) This provides wide band performance of 40 MHz - 50 GHz. (depending on the bandwidth of the bias tee)

For low frequency extension, the addition of 1  $\mu$ F and 0.01  $\mu$ F bypass capacitors on both VG1 and VD<sub>AUX</sub>, will improve the frequency of operation down to 100 kHz. These capacitors should be positioned as close to the device as possible.

Dynamic gain control is available when operating in the linear gain region through the application of 0 to 1.6 V to V<sub>G2</sub>.

Data in this datasheet was measured using bypass capacitors on  $V_{\text{G1}}$  and  $VD_{\text{AUX}}$ .

The evaluation board is configured as shown in the Application Schematic with a direct connection to VG1 for lower gate voltage, typically 0.65 V with IG1 of 1 mA.

As an alternate configuration, VG1 can be shifted to >3 V by grounding VG<sub>AUX</sub>. Note that this will increase IG1 to 21 mA. This is not a typical configuration and is available only for legacy applications that require VG1 > 3 V.

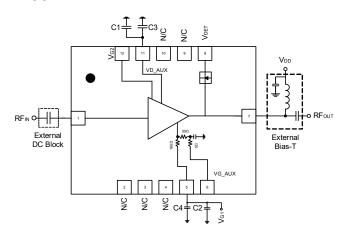
# Operating the MAAM-011238 Turn-on

- 1. Apply  $V_{G1}$  to 0 V.
- 2. Apply V<sub>DD</sub> to 6 V.
- 3. Set I<sub>DSQ</sub> by adjusting V<sub>G1</sub> more positive. (typically 0.65 V for I<sub>DSQ</sub> = 135 mA).
- 4. Apply RF<sub>IN</sub> signal.

#### Turn-off

- 1. Remove RF<sub>IN</sub> signal.
- 2. Decrease Vg1 to 0 V.
- 3. Decrease V<sub>DD</sub> to 0 V.

#### **Application Schematic**



#### **Component List**

Part	Value	Case Style
C1, C2	1 μF	0603
C3, C4	0.01 μF	0402

# Absolute Maximum Ratings<sup>7,8</sup>

Parameter	Absolute Maximum
Input Power	16 dBm
Drain Supply Voltage	8 V
Junction Temperature <sup>9,10</sup>	+150°C
Operating Temperature	-40°C to +85°C
Storage Temperature	-65°C to +150°C

- Exceeding any one or combination of these limits may cause permanent damage to this device.
- MACOM does not recommend sustained operation near these survivability limits.
- Operating at nominal conditions with T<sub>J</sub> ≤ +150°C will ensure MTTF > 1 x 10<sup>6</sup> hours.
- 10.Junction Temperature (T<sub>J</sub>) = T<sub>A</sub> +  $\Theta_{JC}$  \* ((V \* I) (P<sub>OUT</sub> P<sub>IN</sub>)) Typical thermal resistance ( $\Theta_{JC}$ ) = 26.3°C/W.

For  $T_{\Delta} = +85^{\circ}C$ .

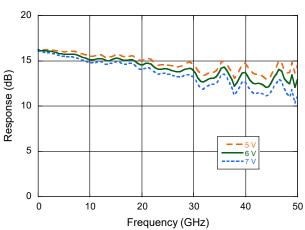
 $T_J = 105$ °C at V = 6 V, I = 0.135 A



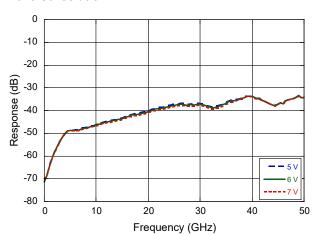
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# Typical Performance Curves: $V_{DD}$ = 6 V, $I_{DSQ}$ = 135 mA, $T_A$ = +25°C

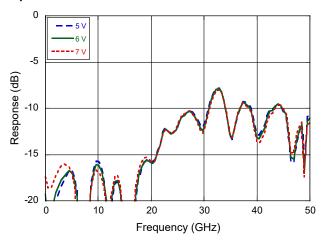




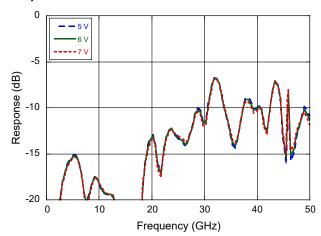
#### Reverse Isolation



#### Input Return Loss



#### **Output Return Loss**





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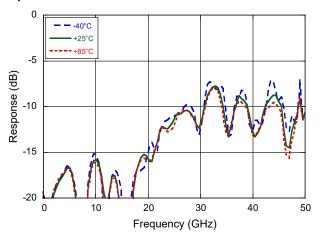
# Typical Performance Curves: $V_{DD} = 6 \text{ V}$ , $I_{DSQ} = 135 \text{ mA}$

# Gain 20 15 15 5 ---40°C ---25°C 0 0 10 20 30 40 50 Frequency (GHz)

# 

Frequency (GHz)

#### Input Return Loss

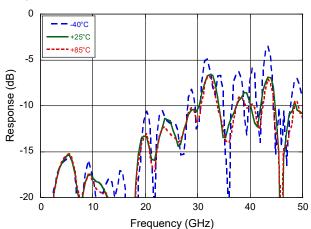


#### **Output Return Loss**

10

-80

Reverse Isolation

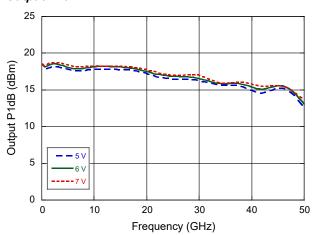




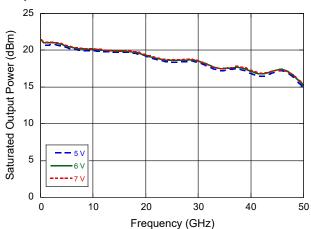
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# Typical Performance Curves: $V_{DD} = 6 \text{ V}$ , $I_{DSQ} = 135 \text{ mA}$ , $T_A = +25 ^{\circ}\text{C}$

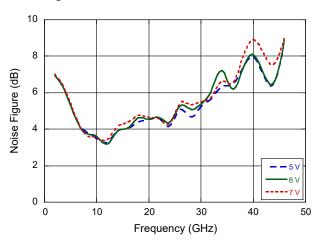
#### **Output P1dB**



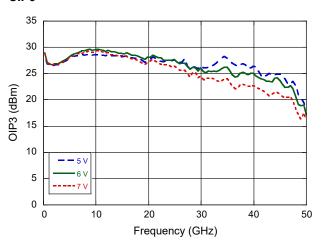
#### **Output P3dB**



#### Noise Figure



#### OIP3

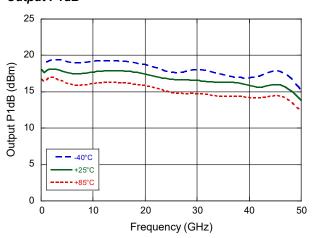




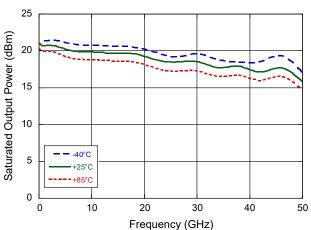
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# Typical Performance Curves: $V_D$ = 6 V, $I_D$ = 135 mA

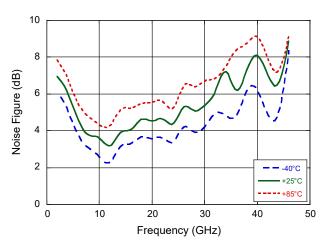
#### **Output P1dB**



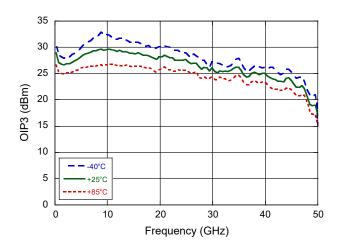
#### Output P3dB



#### Noise Figure



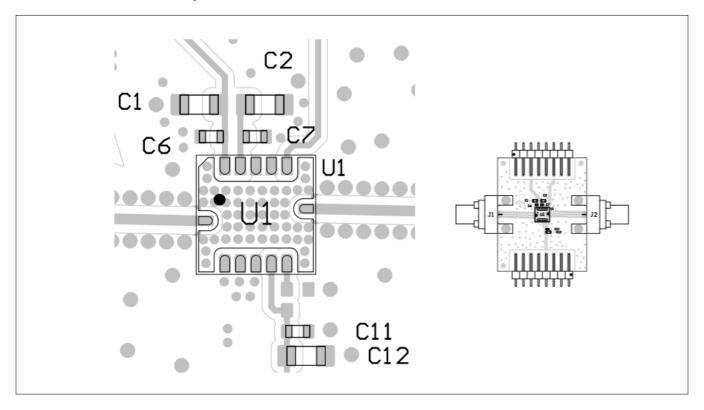
#### OIP3





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# **Recommended PCB Layout**



#### **Evaluation Board Parts List**

Part	Value	Case Style
C1, C2, C12	1 µF	0603
C6 C7, C11	0.01 µF	0402

# **Evaluation PCB Specifications**<sup>11,12</sup>

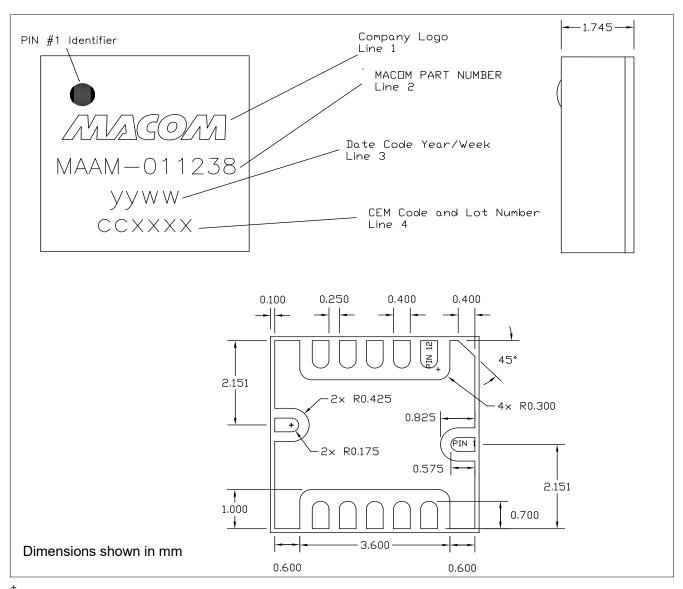
Top Layer: 1 oz Copper Cladding Dielectric Layer: Rogers RO4350B 10 mil Bottom Layer: 1 oz Copper Cladding Finished overall thickness: 12.8 mil

- PCB finish is ENEPIG. The vias (quantity of 50) located under the device are 8 mil in diameter and filled with thermally conductive material, capped over and planarized
- 12. Evaluation board should be mounted on a heat sink.



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# Lead-Free 5 mm 12-Lead QFN Package<sup>†</sup>



Reference Application Note S2083 for lead-free solder reflow recommendations. Meets JEDEC moisture sensitivity level 3 requirements. Plating is ENEPIG over Copper.

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